blandt C 3:23:00

CERTIFICATE OF MAILING PURSUANT TO 37 C.F.R. §1.8

I hereby certify that this correspondence, pursuant to 37 C.F.R. §1.8, is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on:

Date:

3-14-00

By Pamela B. Dennis

Pamela B. Dennis

MAR 2 0 2000 EN

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

<u>PATENT</u>

Applicants: Sugiyama, et al.

08/960,431

Docket No.: Art Unit: 30598.0004

Serial No.: Filed:

October 10, 1997

Examiner:

Nguyen, G.

3723

FOR:

FLATTENING METHOD AND FLATTENING APPARATUS OF A SEMICONDUCTOR

DEVICE

AMENDMENT

Box NON-FEE AMENDMENT Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir:

In response to the Office Actions dated July 12, 1999 and March 6, 2000, please amend the above-identified application as follows:

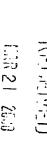
CLAIMS

1. (Twice Amended) A flattening method of a semiconductor device by a chemical-mechanical polishing process comprising,

preparing a synthetic resin polishing cloth in a circular form and a tool for forming a surface

layer of the synthetic resin polishing cloth to have fluff thereon in a polishing process, said tool having [an annular shape with] a diameter less than a radial length of the polishing cloth, and

rotating the polishing cloth along a central axis thereof and pressing the tool on a radial portion of the polishing cloth, said tool being moved along [a radial direction of] the polishing cloth [and perpendicular to the radial direction] to thereby



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Date:

3-14-00

By <u>Jamela B. Denni</u>



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RESPONSE TRANSMITTAL

Applicant(s):

Sugiyama, et al.

Docket No.:

30598.0004

Serial No.:

08/960,431

Group Art Unit:

3723

Filing Date:

October 10, 1997

Examiner:

Nguyen, G.

TITLE:

FLATTENING METHOD AND FLATTENING APPARATUS

OF A SEMICONDUCTOR DEVICE

ICA 21 (23)

0.00

Subtotal:

Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir/Madam:

In response to the Office Actions dated July 12, 1999 and March 6, 2000, please amend the above-identified application as follows:

FEE CALCULATION, CLAIMS AS AMENDED:

	Claims remaining after amendmen		Highest number previously paid for	Present Extra			Additional Fee
Total Effective Claims	21	minus	21=	0 x	\$ 18.00	=	0.00
Independent Claims	4	minus	4=	0 x	\$ 78.00	=	0.00
If amendment enters application for first t				s) into this	\$260.00	+	N/A

Fee Calculation: Request for Extension of Time pursuant to 37 C.F.R. §1.136(a)

[]		Response filed within first month aft	er due date - add	\$ 110.00					
[]		Response filed within second month	n after due date - add	\$ 380.00					
[]]	Response filed within third month at	fter due date - add	\$ 870.00					
[]]	Response filed within fourth month	after due date - add	\$1360.00					
[]]	Response filed within fifth month aft	er due date - add	\$1850.00					
		·		TOTAL:	\$ 0.00				
		of the "small entity" boxes above is chall and subtract	necked, enter half (½) of	the second	N/A				
Info	rma	ation Disclosure Statement Pursuant	to 37 C.F.R. §§1.97-1.9	8	N/A				
	TOTAL ADDITIONAL FEE ENCLOSED: \$ 0.00								
[]Please charge Deposit Account No. 08-2727 in the amount of \$ A duplicate copy of this sheet is attached.									
[]		Check No in the amou	unt of <u>\$</u> is atta	ached.					
the any only C.F.	fee pa /) n .R.	This statement does NOT authorical authorized to charge any other fees (s) filed, or asserted to be filed, or we per filed hereafter, and which may be own or hereafter relative to this Appli §1.20, or credit any overpayment ate copy of this sheet is attached.	pecifically authorized he hich should have been e required under 37 C.F cation and the resulting	ereafter, or any defi filed herewith or co F.R. §§1.16-1.18 (d) Official document	ciency in oncerning eficiency under 37				
			Respectfully submitted	1					
			R. Lee Fraley Reg. No. 42,556	ally					
CNIE	=1.1	e MIII MED I I D	Dated:						

SNELL & WILMER, L.L.P. One Arizona Center 400 East Van Buren Phoenix, Arizona 85004-0001 (602) 382-6305